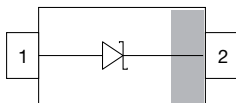


Small Signal Schottky Diodes



LINKS TO ADDITIONAL RESOURCES



MECHANICAL DATA

Case: SOD-123

Weight: approx. 10.6 mg

Packaging codes/options:

18/10K per 13" reel (8 mm tape), 10K/box

08/3K per 7" reel (8 mm tape), 15K/box

FEATRUERS

- For general purpose applications
- The low forward voltage drop and fast switching make it ideal for protection of MOS devices, steering, biasing and coupling diodes for fast switching and low logic level applications
- The SD101 series is a metal-on-silicon Schottky barrier device which is protected by a PN junction guarding
- AEC-Q101 qualified available (part number on request)
- Molding compound meets UL 94 V-0 flammability rating
- Moisture Sensitivity Level (MSL) 1
- Base P/N-G3 - green, commercial grade
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



PARTS TABLE

PART	ORDERING CODE	AEC-Q101 QUALIFIED	TYPE MARKING	CIRCUIT CONFIGURATION	TAPED UNITS PER REEL	MINIMUM ORDER QUANTITY
SD101AW-G	SD101AW-G3-08	no	SK	Single	3 000 (8 mm tape on 7" reel)	15 000
	SD101AW-G3-18	no			10 000 (8 mm tape on 7" reel)	10 000
SD101BW-G	SD101BW-G3-08	no	SL	Single	3 000 (8 mm tape on 7" reel)	15 000
	SD101BW-G3-18	no			10 000 (8 mm tape on 7" reel)	10 000
SD101CW-G	SD101CW-G3-08	no	SM	Single	3 000 (8 mm tape on 7" reel)	15 000
	SD101CW-G3-18	no			10 000 (8 mm tape on 7" reel)	10 000

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified)

PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT
Repetitive peak reverse voltage		SD101AW-G	V _{RRM}	60	V
		SD101BW-G	V _{RRM}	50	V
		SD101CW-G	V _{RRM}	40	V
Power dissipation	on FR-4 board with recommended soldering footprint		P _{tot}	230	mW
	Infinite heatsink			330	mW
Forward continuous current ⁽¹⁾			I _F	100	mA
Maximum single cycle surge	10 μs square wave		I _{FSM}	2	A

Note

⁽¹⁾ Infinite heatsink

**THERMAL CHARACTERISTICS** ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Thermal resistance junction to ambient air	according to JEDEC® 51-3 on FR-4 board with recommended soldering footprint	R_{thJA}	420	K/W
Thermal resistance junction lead	Infinite heatsink	R_{thJL}	300	K/W
Maximum junction temperature		T_j	125	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	-65 to +150	$^{\circ}\text{C}$
Operating temperature range		T_{op}	-55 to +150	$^{\circ}\text{C}$

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Reverse breakdown voltage	$I_R = 10\text{ }\mu\text{A}$	SD101AW-G	$V_{(BR)}$	60			V
		SD101BW-G	$V_{(BR)}$	50			V
		SD101CW-G	$V_{(BR)}$	40			V
Leakage current	$V_R = 50\text{ V}$	SD101AW-G	I_R			200	nA
	$V_R = 40\text{ V}$	SD101BW-G	I_R			200	nA
	$V_R = 30\text{ V}$	SD101CW-G	I_R			200	nA
Forward voltage drop	$I_F = 1\text{ mA}$	SD101AW-G	V_F			410	mV
		SD101BW-G	V_F			400	mV
		SD101CW-G	V_F			390	mV
	$I_F = 15\text{ mA}$	SD101AW-G	V_F			1000	mV
		SD101BW-G	V_F			950	mV
		SD101CW-G	V_F			900	mV
Diode capacitance	$V_R = 0\text{ V}$, $f = 1\text{ MHz}$	SD101AW-G	C_D			2	pF
		SD101BW-G	C_D			2.1	pF
		SD101CW-G	C_D			2.2	pF
Reverse recovery time	$I_F = I_R = 5\text{ mA}$, recover to $0.1\text{ }I_R$		t_{rr}			1	ns



TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

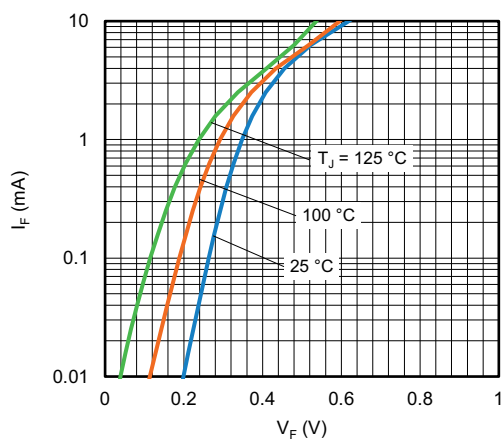


Fig. 1 - Typical Forward Current vs. Forward Voltage

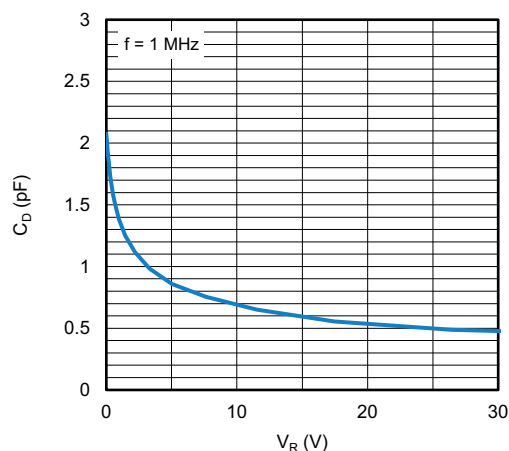


Fig. 3 - Typical Capacitance vs. Reverse Voltage

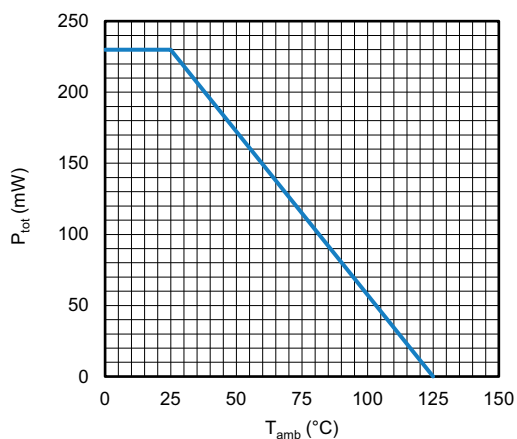


Fig. 2 - Admissible Power Dissipation vs. Ambient Temperature

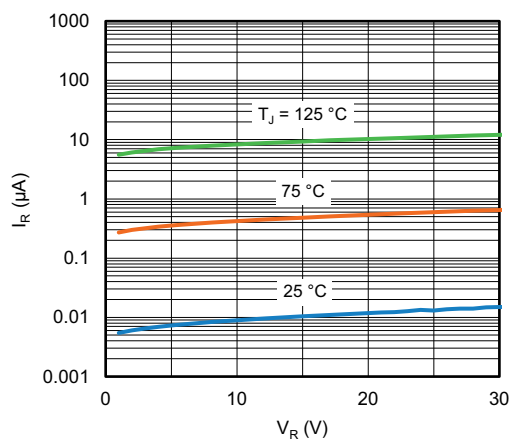
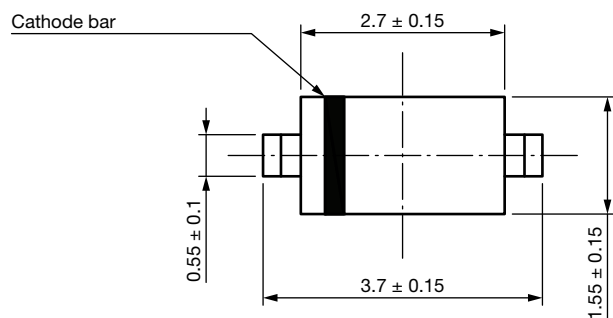
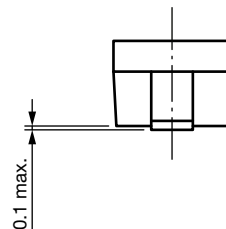


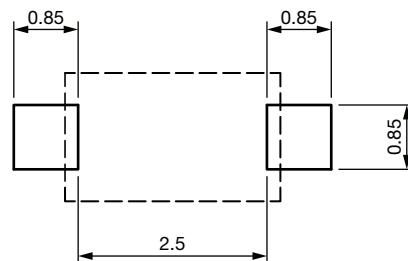
Fig. 4 - Typical Reverse Leakage vs. Reverse Voltage



PACKAGE DIMENSIONS in millimeters (inches): SOD-123



Foot print recommendation



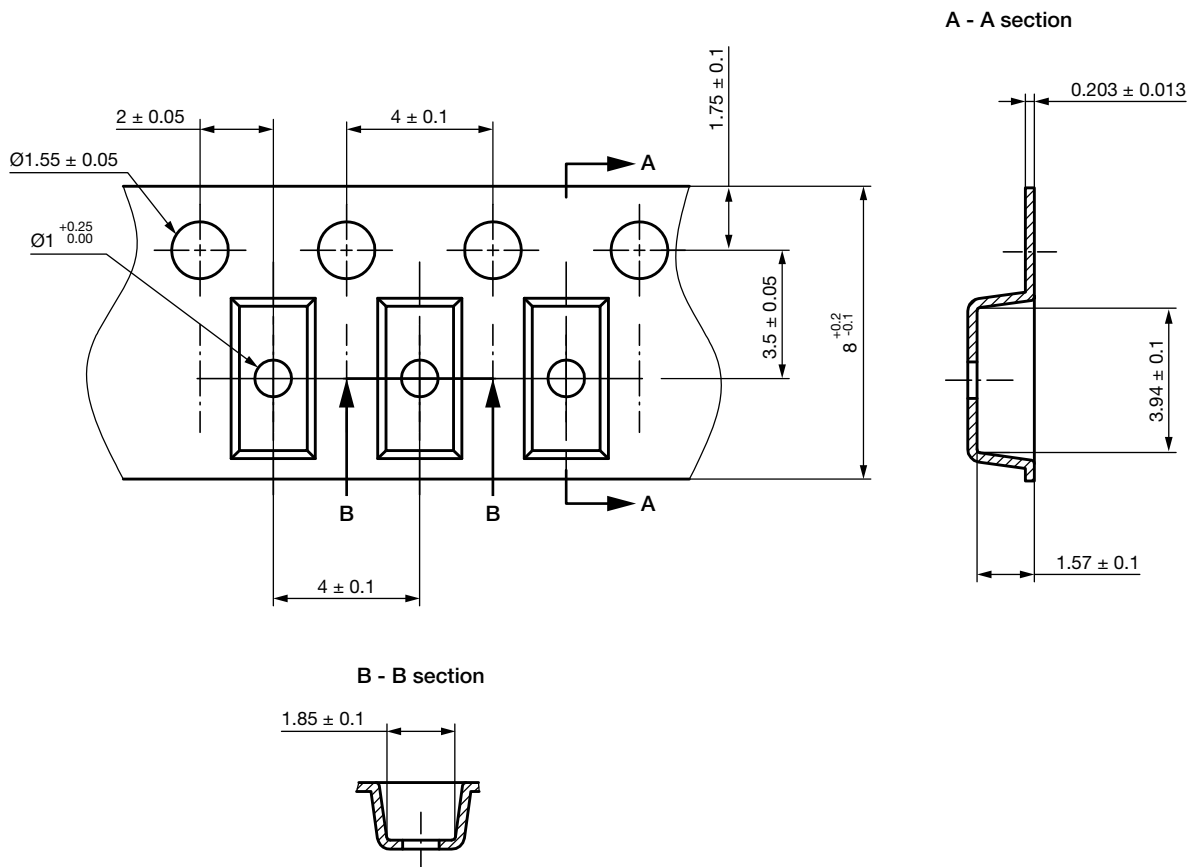
Rev. 01 - Date: 18. Jan. 2022

Document no.: S8-V-3910.01-003 (4)

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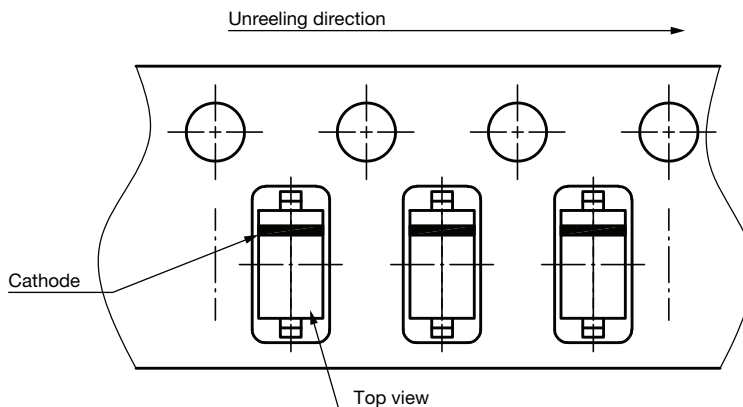
CARRIER TAPE SOD-123



Rev. 02 - Date: 21. Jan. 2014
Document no.: S8-V-3717.10-002 (4)

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ORIENTATION IN CARRIER TAPE SOD-123



Rev. 02 - Date: 07. Nov. 2022
Document no.: S8-V-3717.10-003 (4)

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